

Chipset architectures for 1.9GHz

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www.sequans.com

4G Semiconductor Innovation



Sequans Communications An Overview

Sequans	A leading fabless 4G semiconductor vendor serving LTE and WIMAX device markets worldwide. Shipped over 15 Million chipsets to date. Over 250 employees worldwide.
History	Venture capital-backed operations began in 2004. IPO launched April 15, 2011 on NYSE: SQNS
Headquarters	Paris, France
Global Presence	HQ and main R&D in Paris; R&D centers in UK, Israel, Ukraine, employees in 11 countries Operations, sales, support in China, Taiwan, Japan, India, Korea, Singapore, Hong Kong, Israel, US
Technology	4G SoC solutions for handsets, embedded and external modems, CPE. 4G 'slim modem' architecture delivers low cost, low power, fast TTM and best-of-breed performance.
Market Position	Sequans no. 1 in 4G smart phones, estimated overall 35% market share in 2010 Provides one of the earliest available and most advanced TDD LTE solutions
Operator and Ecosystem Acceptance	Deployed in top WiMAX networks: Sprint, KDDI, KT, Yota, BSNL, Tata, PacketOne, UQC, Key customers: HTC, Huawei, ZTE, Gemtek, Ubee, Zyxel, Quanta, Accton, Alvarion, Sagemcom LTE chips targeting trials at China Mobile, Reliance, Airtel, Softbank, Clearwire, NBN, STC, Sprint IOT Partnerships with: Ericsson, Huawei, ZTE, Alcatel Lucent, Nokia-Siemens Networks, Samsung



Mass-Market 4G Handsets and Tablets

A Sample of Mobile Devices Powered by Sequans 4G Technology





HTC Evo 4G June, 2010 WiMAX + EVDO



HTC Evo WiMAX



April, 2011

WiMAX + EVDO

HTC Evo 3D June, 2011 WiMAX + EVDO





HTC Evo 4G+ July, 2011 WiMAX + HSPA



HTC Evo Design 4G October, 2011 WiMAX + EVDO



HTC Evo 3D October, 2011 WiMAX + EVDO



Sharp 7" Tablet AAEON/Asus ETBW11AA December, 2011 January, 2012 WiMAX + EVDO WiMAX + EVDO

Enabling Mass-Market 4G Globally



Sequans LTE: Global Acceptance





Introducing "Andromeda" and "Mont Blanc" Next-generation LTE Platforms

Leading-edge technology

- 3GPP Release 9 compliant
- Category 4 throughput, up to 150Mbps downlink rate
- Worldwide FDD and TDD band support
- 40nm baseband design is power-, sizeand cost-efficient

Andromeda LTE platform

- Designed for smartphones, tablets
- Slim-modem design enables ultra low power, small form-factor

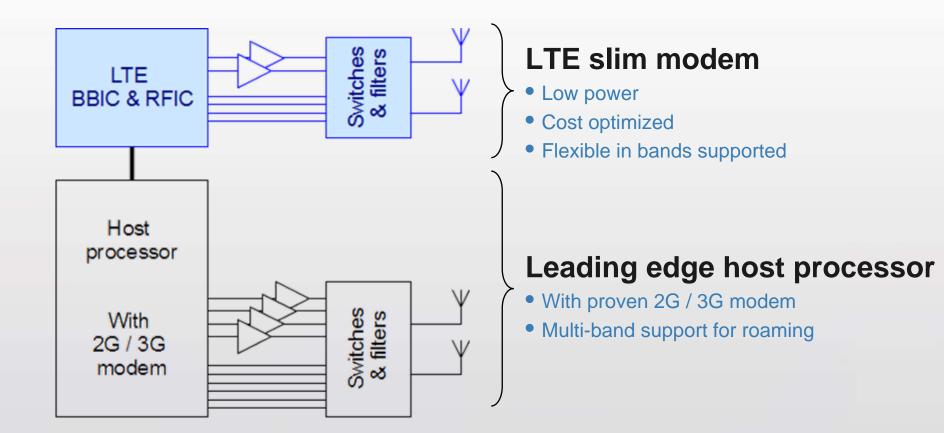
Mont Blanc LTE platform

- Designed for data devices
- Data-friendly interfaces, integrated apps processor enables high performance, lowcost, power-efficient mobile hotspots, USB dongles, CPE





Slim Modem Architecture





Sequans support for 1.9GHz

- Sequans has been supporting CMCC for TD-LTE from early days
 - Supported Shanghai World Expo in May 2010 with B38/B40 USB dongle
 - Completed MIIT Phase 1 testing
- Sequans has entered into partnership with NationZ to address MIIT Phase 2 testing
 - Solution based on NationZ Zi2010 RFIC
 - Addressing B38, B39 and B40
- Sequans & NationZ will continue collaboration for future optimization of multi-band products (including 1.9GHz)



Nationz LTE RFIC Roadmap

Advanced RF CMOS

Multi-Band, Multi-System

TD-LTE: B38,39,40

LTE FDD: B7



ZI2010

Apr 2010, TD-LTE RFIC, support



ZI2010V2

Aug 2011, support

TD-LTE/LTE FDD

TD-SCDMA: B34/39/40

ZI2020 55nm 2012Q3

ZI2020

3Q2012, 2/3/4G multi-band, multi-system

TD-LTE/LTE FDD

TD-SCDMA

WCDMA

GSM/GPRS/EDGE

2010

2011

2012

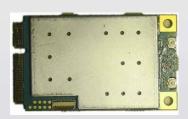


Sequans offering at 1.9GHz, available in middle of 2012

USB Dongle



Mini PCI-e Module



Indoor CPE



Mobile Router







- Sequans current LTE solutions
 - > Enable the lowest cost
 - Deliver maximum performance
 - Consume minimal power
- Sequans has strategic investment in 1.9GHz band
 - Fully qualified solution
 - Numerous products available

